

PATENT ASSIGNMENT COVER SHEET

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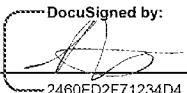
SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
LESLIE PETER BENZIES	05/12/2022
RECEIVING PARTY DATA	
Name:	BUILD A ROCKET BOY LTD.
Street Address:	29 CONSTITUTION STREET
City:	EDINBURGH
State/Country:	UNITED KINGDOM
Postal Code:	EH6 7BS
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17265124
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DATE SIGNED:	05/12/2022
Total Attachments: 1	
source=P22399 Assignment SIGNED#page1.tif	

ASSIGNMENT

Names of Inventors/Assignors: **Leslie Peter Benzies**
 Name of Assignee: **Build a Rocket Boy Ltd. (f/k/a Royal Circus Limited)**
 Country of Formation of Assignee: **United Kingdom**
 Title of Application: **SYSTEM AND METHOD FOR PROVIDING A COMPUTER-GENERATED ENVIRONMENT**
 Application No.: 17/265,124 Date of Filing of Application: 02/01/2021

In consideration of the sum of \$1.00 and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged by each of the undersigned Inventors/Assignors:

1. I hereby sell, assign and transfer and do hereby sell, assign and transfer to the above-named Assignee, its successors and assigns, my entire and exclusive right, title and interest in and to the inventions claimed and described in the above-identified patent application in the United States and throughout the world, and in and to any applications for patent and patents which may be granted and issued thereon in any and all countries, and in and to any continuations, divisions, reissues and extensions of said applications and patents and all priority rights associated therewith. I agree to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.
2. Without cost to the undersigned, I agree to perform all affirmative acts which may be necessary to obtain a grant of original, reissue or reexamined patents on the invention.
3. I agree to execute all papers and documents and to perform any act necessary in connection with provisions of any and all international treaties regarding patents and industrial property.
4. I irrevocably appoint the Assignee corporation's president or limited liability company's managing members, as the case may be, to act as my agent and attorney-in-fact to perform all acts necessary to obtain and/or maintain patents to any inventions assigned under this assignment if I refuse to perform those acts, or am unavailable, within the meaning of any applicable laws. I acknowledge that the grant of the foregoing power of attorney is coupled with an interest and shall survive my death or disability.
5. I hereby authorize and request that all resulting patents be issued to the Assignee, as assignee of the entire interest.
6. I covenant to having full right to convey the entire interest herein assigned. I represent and warrant that no other assignment, sale, agreement or encumbrance has been or will be made or entered into by me which would conflict with this assignment. This assignment stands on its own.
7. The undersigned authorizes the Assignee or its agent to fill in the application number and filing date, if necessary.
8. I acknowledge that Assignee's patent attorney represents Assignee, and not me, and that I have had an opportunity to retain my own patent counsel.
9. The Assignee shall have the right to assign this Assignment and the rights hereunder, and each later assignee shall have the rights of the Assignee hereunder.

Signature of Inventor:  Date: 5/12/2022
 DocuSigned by: 2460FD2F71234D4...

Assignee hereby accepts this Assignment:  Date: 5/12/2022
 DocuSigned by: 2460FD2F71234D4...